

TAIWAN SEMICONDUCTOR MANUFACTURING CO LTD

Form 6-K

August 08, 2017

**1934 Act Registration No. 1-14700**

**SECURITIES AND EXCHANGE COMMISSION**

**Washington, DC 20549**

**FORM 6-K**

**REPORT OF FOREIGN PRIVATE ISSUER**

**PURSUANT TO RULE 13a-16 OR 15d-16 OF**

**THE SECURITIES EXCHANGE ACT OF 1934**

**For the month of August 2017**

**Taiwan Semiconductor Manufacturing Company Ltd.**

**(Translation of Registrant's Name Into English)**

**No. 8, Li-Hsin Rd. 6,**

**Hsinchu Science Park,**

**Taiwan**

**(Address of Principal Executive Offices)**

(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)

Form 20-F

Form 40-F

(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)

Yes

No

(If Yes is marked, indicated below the file number assigned to the registrant in connection with Rule 12g3-2(b): 82: \_\_\_\_\_.)

**SIGNATURES**

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Taiwan Semiconductor Manufacturing Company Ltd.

Date: August 8, 2017

By /s/ Lora Ho

Lora Ho

Senior Vice President & Chief Financial Officer

**TSMC Board of Directors Meeting Resolutions**

**Hsinchu, Taiwan, R.O.C., August 8, 2017** TSMC (NYSE: TSM) today held a meeting of the Board of Directors, which approved capital appropriations of approximately US\$3,153.6 million for purposes including: 1) Construction of fab facilities for US\$528 million; 2) Other purposes for US\$2,625.6 million including: Expanding and upgrading advanced technology equipment; Expanding advanced packaging technology capacity; Upgrading specialty technology capacity; Conversion of logic capacity to specialty technology; Fourth quarter 2017 R&D capital investments and sustaining capital expenditures.

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**TSMC Spokesperson:**

Ms. Lora Ho

Senior Vice President and CFO

Tel: 886-3-566-4602

**TSMC Acting Spokesperson:**

Dr. Elizabeth Sun

Senior Director

Corporate Communications Division

Tel: 886-3-568-2085

Mobile: 886-988-937999

E-Mail: elizabeth\_sun@tsmc.com